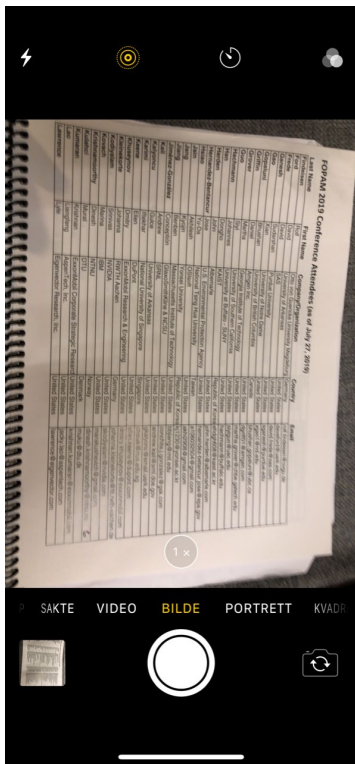


From: [Sayed Sayed](#)
 To: [Sayed Sayed](#)
 Subject: Participants FOPAM 2019
 Date: Monday, 22 August 2019 01:41:08
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